LTCC SURFACE MOUNT

Low Pass Filter

LFHKI-3800+

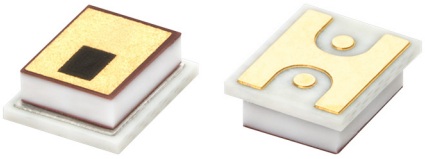
50 Ω DC to 3.8 GHz

THE BIG DEAL

- Low Insertion Loss, Typ. 1.1 dB
- Passband Return Loss, Typ. 13 dB
- Stopband Rejection, Typ. 50 dB
- 1008 Surface Mount Footprint
- Power Handling: 9.5 W
- Shielded Construction
- Protected by US Patents 11,638,370 and 11,744,057

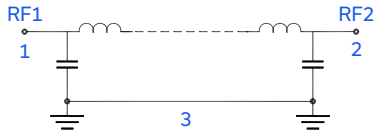
APPLICATIONS

- Test and Measurement Equipment
- VHF/UHF Transmitters / Receivers
- Lab Use
- Harmonic Rejection



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' LFHKI-3800+ is a miniature low temperature co-fired ceramic (LTCC) low pass filter with a DC to 3.8 GHz passband supporting a variety of applications. This model provides 1.1 dB typical insertion loss over a wide band due to its rugged monolithic construction. Housed in a small 1008 ceramic form factor, the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	DC-F1	DC -3.8	—	1.1	1.6	dB
	Freq. Cut-Off[4]	Fc	4.8	—	3	—	dB
	Return Loss	DC-F1	DC – 3.8	10	13	—	dB
Stopband	Rejection	F2-F3	5.8 – 8.3	20	25	—	dB
		F3-F4	8.3 – 13	40	50	—	
		F4-F5	13 – 25	40	50	—	
		F5-F6	25 - 35	25	37	—	
		F6-F7	35 - 46	20	37	—	

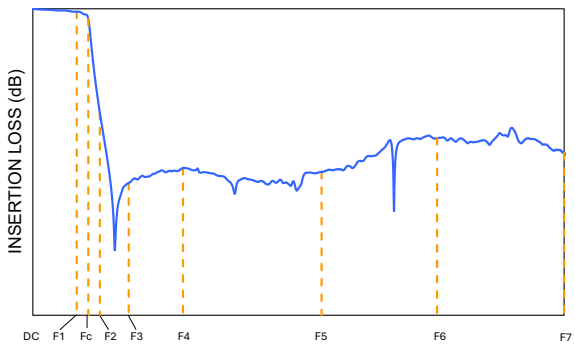
1. Tested in Evaluation Board P/N TB-LFHKI-3800C+
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ± 5%

ABSOLUTE MAXIMUM RATINGS[5]

Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power[6]	9.5 W

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 1.6 W at +125 °C.

TYPICAL FREQUENCY RESPONSE



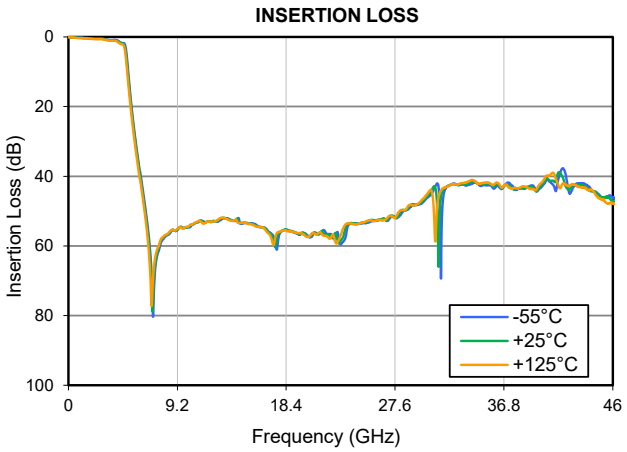
REV. OR
ECO-027080
LFHKI-22850+
MCL NY
250929

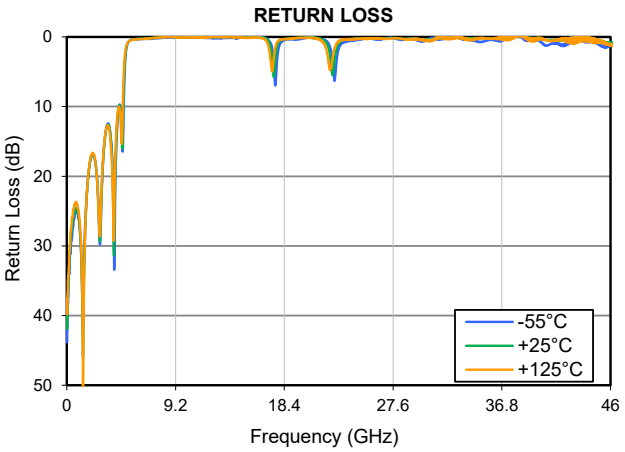
Low Pass Filter

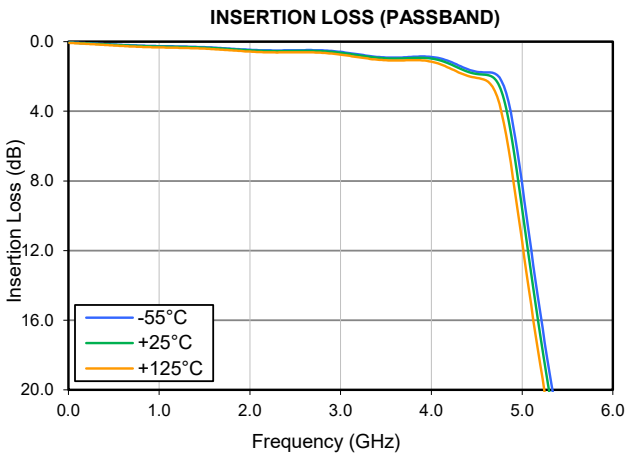
LFHKI-3800+

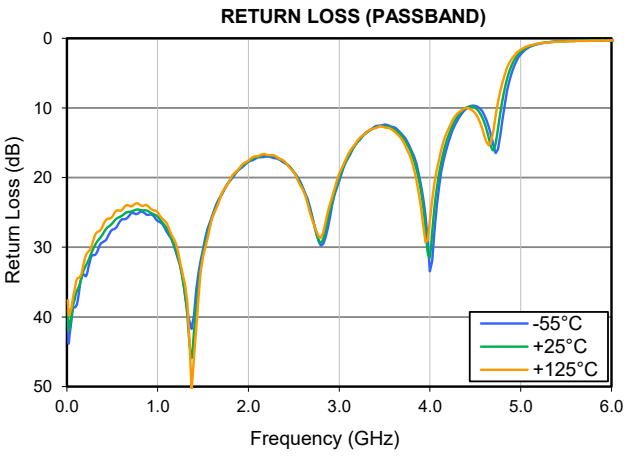
50 Ω DC to 3.8 GHz

TYPICAL PERFORMANCE GRAPHS









Low Pass Filter

LFHKI-3800+

50 Ω DC to 3.8 GHz

FUNCTIONAL DIAGRAM

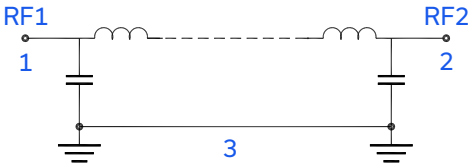
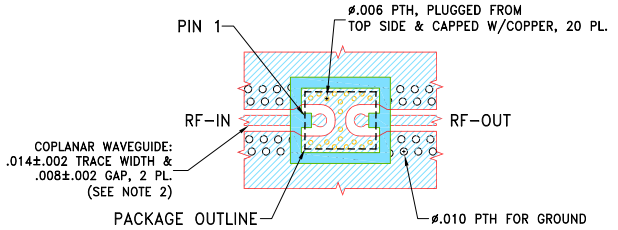


Figure 1. LFHKI-3800+ Functional Diagram

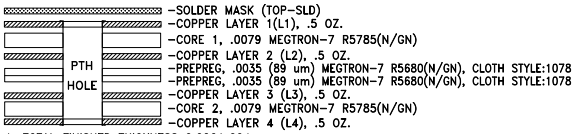
PAD DESCRIPTION

Function	Pad Number	Description
RF1	1	Connects to RF Input Port
RF2	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-836)

SUGGESTED PCB LAYOUT (PL-836)



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS 0.026±.004.
2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
3. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
4. L2, L3, AND L4 ARE CONTINUOUS GROUND PLANES.

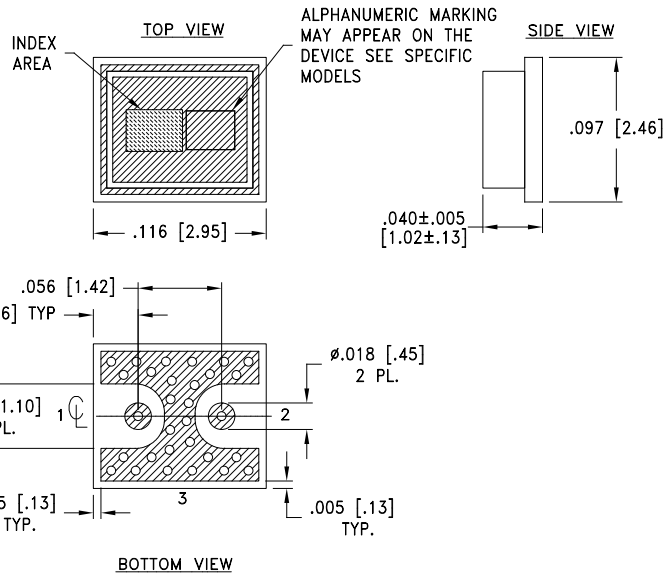
NOTES:
1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP ARE SHOWN FOR MEGTRON-7 R5785(N/GN) WITH DIELECTRIC THICKNESS .0079", COPPER: 1 OZ. EACH LAYER. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
3. LAYERS L2, L3 & L4 OF PCB ARE CONTINUOUS GROUND PLANES.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Figure 2. Suggested PCB Layout

CASE STYLE DRAWING



METALLIZATION

Weight: .021 grams
Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.015 Inches

PRODUCT MARKING*: E7

*Marking may contain other features or characters for internal lot control.

Low Pass Filter

LFHKI-3800+

50 Ω DC to 3.8 GHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD CLICK HERE

Performance Data & Graphs	Data Graphs S-Parameter (SxP Files) Data Set (.zip file) De-embedded to device pads
Case Style	NM3723 Lead Finish: Gold Plate over Nickel Plate
RoHS/REACH Status	Compliant
Tape and Reel	F66-2
Suggested Layout for PCB Design	PL-836
Evaluation Board	TB-LFHKI-3800C+ Gerber File
Environmental Rating	ENV06T10

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

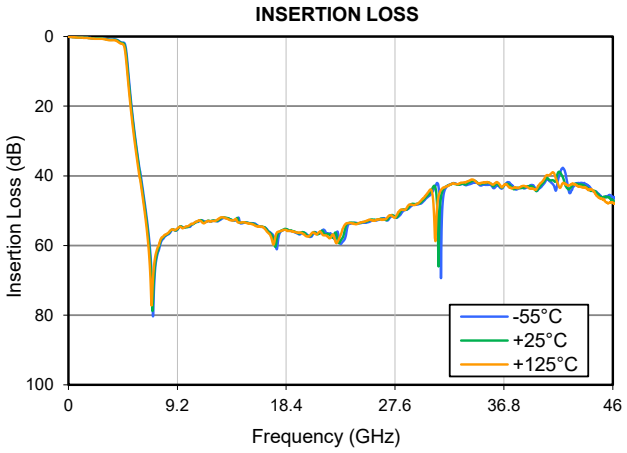
LTCC Low Pass Filter LFHKI-3800+

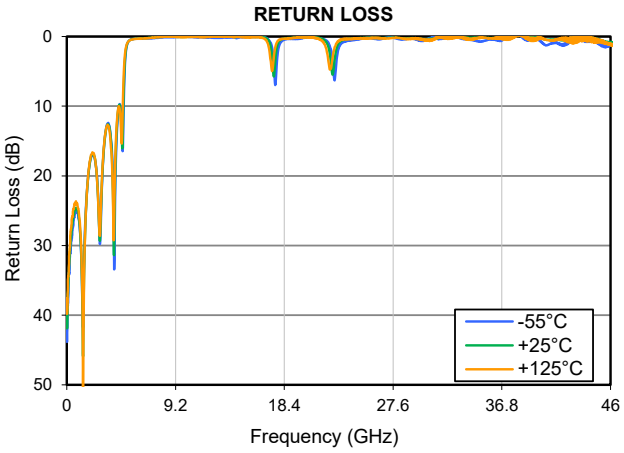
Typical Performance Data

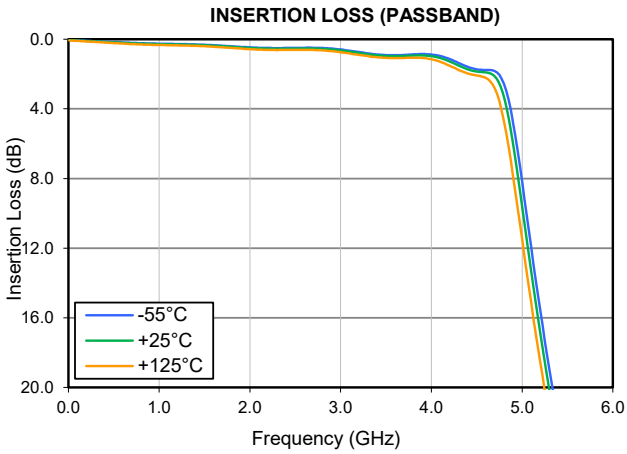
FREQUENCY (GHz)	INSERTION LOSS (dB)			RETURN LOSS (dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
0.01	0.04	0.05	0.07	40.47	39.03	37.57
0.05	0.05	0.06	0.08	40.57	40.06	38.77
0.10	0.07	0.08	0.10	38.44	36.63	34.94
0.20	0.09	0.10	0.13	34.12	32.85	31.52
0.30	0.12	0.13	0.16	31.15	29.96	28.64
0.40	0.14	0.16	0.19	29.24	28.01	26.82
0.50	0.16	0.18	0.22	27.49	26.56	25.60
0.60	0.19	0.21	0.25	26.04	25.52	24.70
0.70	0.21	0.23	0.28	25.21	24.89	24.14
0.80	0.23	0.25	0.30	24.98	24.62	23.86
0.90	0.24	0.27	0.32	25.33	24.85	24.14
1.00	0.26	0.28	0.33	26.20	25.62	24.95
1.20	0.28	0.30	0.35	30.71	30.27	29.42
1.40	0.30	0.33	0.38	39.81	42.15	45.85
1.60	0.34	0.37	0.43	25.56	25.73	25.80
1.80	0.41	0.44	0.50	20.39	20.29	20.21
2.00	0.47	0.50	0.57	17.72	17.67	17.57
2.20	0.50	0.54	0.61	16.98	16.80	16.71
2.40	0.50	0.54	0.62	17.94	17.76	17.71
2.60	0.49	0.53	0.61	21.45	21.61	21.76
2.80	0.50	0.55	0.64	29.79	29.33	28.63
3.00	0.59	0.64	0.75	20.45	19.97	19.42
3.20	0.74	0.79	0.90	14.94	14.90	14.72
3.40	0.87	0.92	1.03	12.64	12.82	12.88
3.60	0.92	0.97	1.09	12.77	13.02	13.31
3.80	0.87	0.94	1.07	16.21	16.63	17.63
4.00	0.88	0.97	1.15	33.45	31.39	26.22
4.50	1.73	1.86	2.08	9.72	9.99	10.75
5.00	8.19	9.59	11.50	2.28	1.92	1.62
5.50	24.99	26.10	27.54	0.39	0.40	0.44
6.00	37.58	38.60	39.91	0.32	0.28	0.30
6.50	49.28	50.42	52.06	0.29	0.24	0.28
7.00	66.17	69.90	75.89	0.27	0.19	0.22
7.50	62.98	62.03	61.12	0.22	0.11	0.12
8.00	58.07	57.65	57.40	0.15	0.05	0.07
8.50	56.64	56.32	56.11	0.12	0.02	0.03
9.00	55.65	55.63	55.60	0.10	0.03	0.02
10.00	54.67	54.74	54.51	0.02	0.06	0.09
11.00	53.12	52.95	52.77	0.10	0.03	0.07
12.00	53.15	53.05	53.15	0.16	0.04	0.05
13.00	52.18	51.95	51.89	0.17	0.03	0.04
14.00	52.81	52.72	52.68	0.15	0.00	0.03
15.00	53.39	53.37	53.49	0.09	0.03	0.11
16.00	54.29	54.45	54.55	0.04	0.06	0.10
17.00	56.11	56.31	56.79	0.33	0.41	0.96
18.00	55.86	55.70	55.77	1.15	0.63	0.47
19.00	56.05	55.87	56.02	0.34	0.19	0.23
20.00	56.40	56.45	57.12	0.20	0.10	0.12
21.00	56.43	56.76	56.75	0.20	0.10	0.17
22.00	56.62	56.75	57.83	0.61	0.95	2.11
23.00	59.53	58.60	57.08	1.73	0.97	0.57
24.00	53.59	53.46	53.62	0.50	0.32	0.40
25.00	53.43	53.23	53.14	0.33	0.21	0.23
26.00	52.80	52.68	52.71	0.28	0.21	0.25
27.00	52.73	52.31	51.75	0.19	0.19	0.27
28.00	51.30	50.64	49.91	0.34	0.18	0.19
29.00	48.52	48.06	48.32	0.32	0.23	0.28
30.00	47.32	46.87	46.36	0.56	0.39	0.51
31.00	42.83	43.28	58.72	0.25	0.28	0.32
32.00	43.04	42.87	42.94	0.09	0.16	0.30
33.00	42.53	42.57	42.25	0.10	0.05	0.00
34.00	42.26	41.67	41.16	0.36	0.22	0.45
35.00	42.57	42.18	41.96	0.74	0.16	0.12

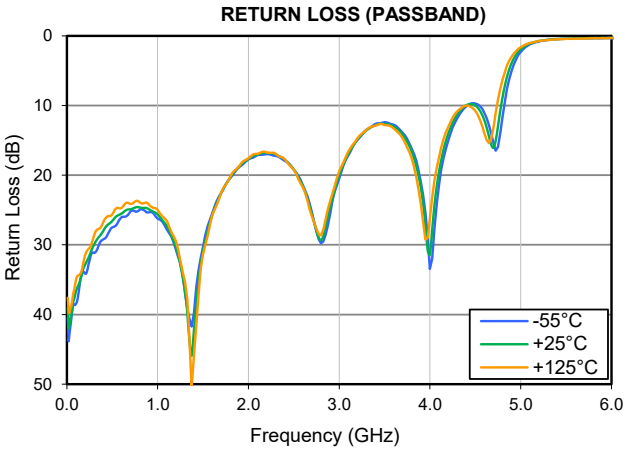
LTCC Low Pass Filter LFHKI-3800+

Typical Performance Data





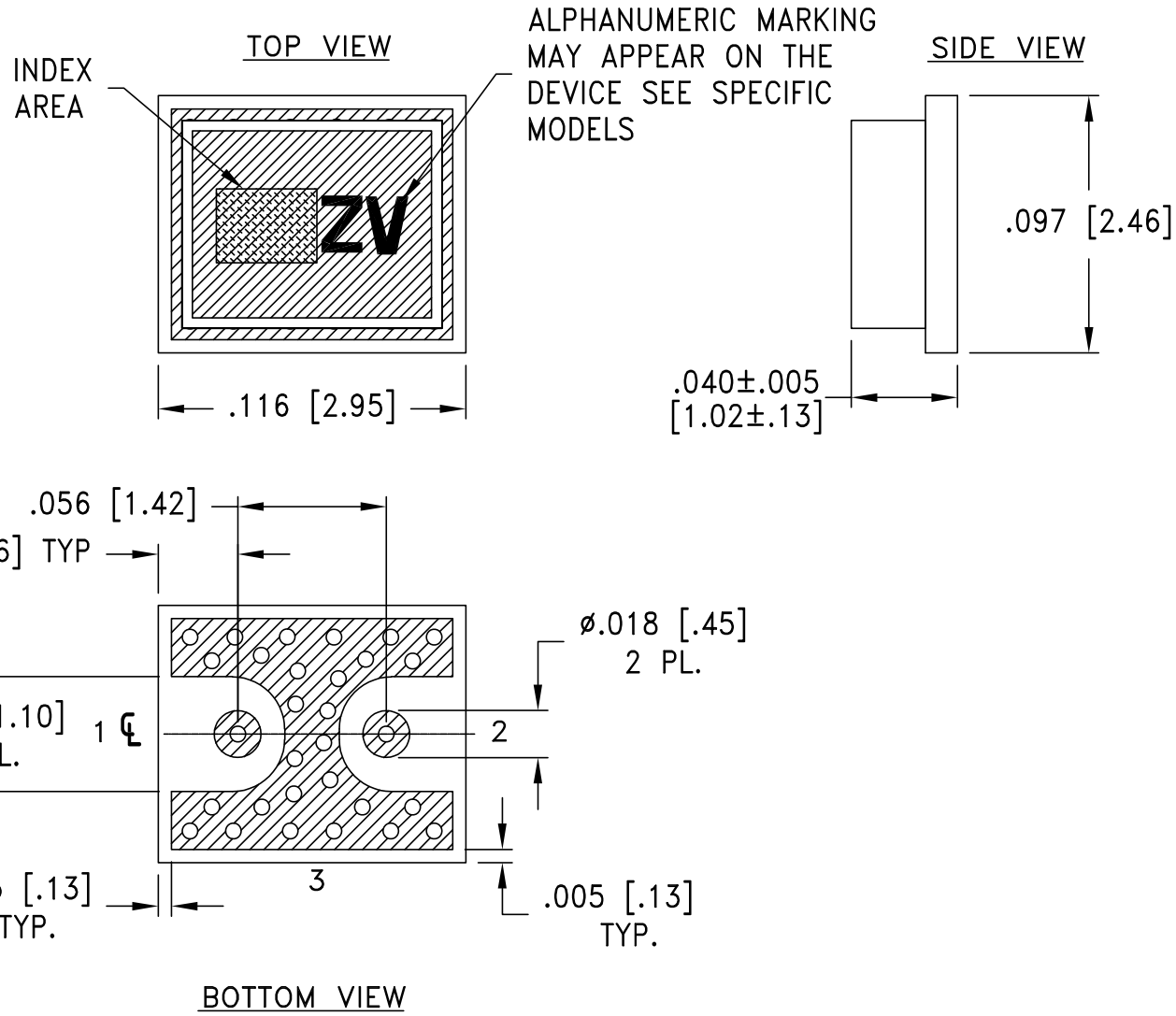




Case Style NM

Outline Dimensions

NM3723



Weight: .021 grams

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 inches

Notes:

1. Case material: LTCC on printed circut board base.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Gold Plate over Nickel plate. All models, (+) suffix.

Mini-Circuits®

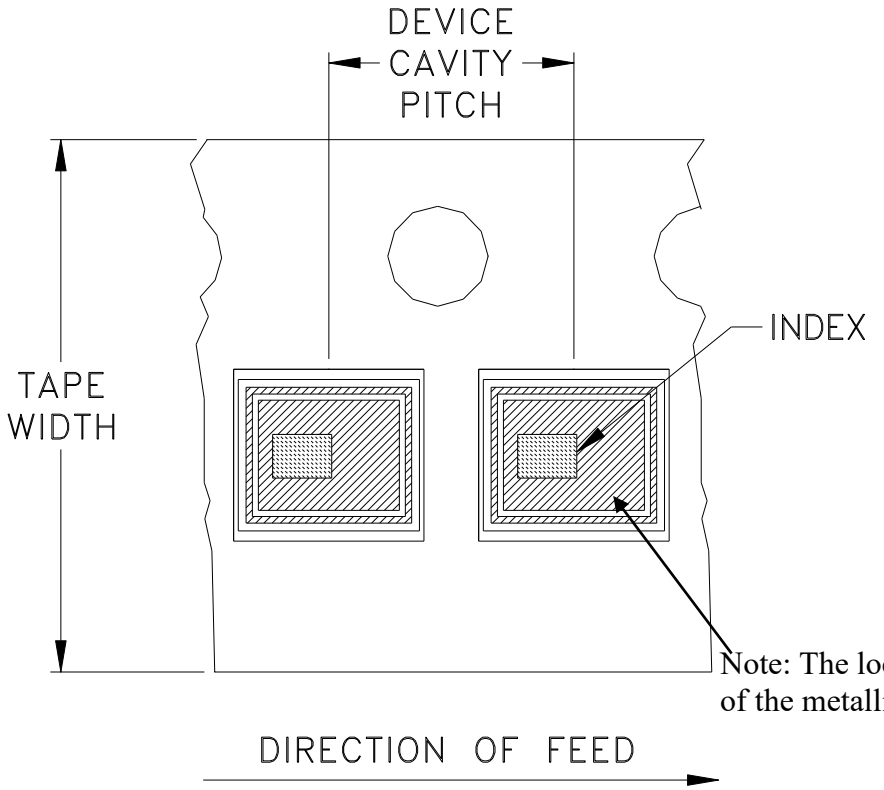
INTERNET http://www.minicircuits.com

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

*Mini-Circuits **ISO 9001 & ISO 14001** Certified*

Tape & Reel Packaging TR-F66-2



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20
				50
				100
				200
				500
		7	Standard	1000, 2000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

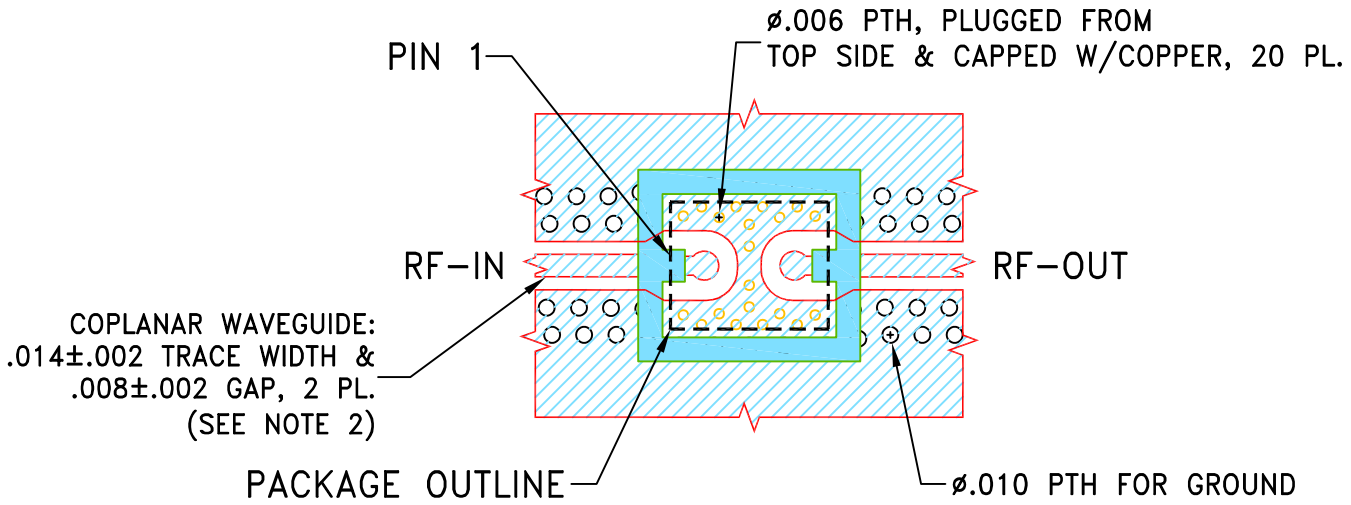
Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

This document and its contents are the property of Mini-Circuits.

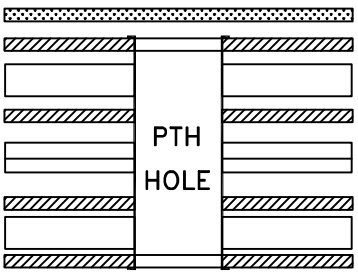
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-026948	NEW RELEASE	09/15/25	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR NM3723 CASE STYLE



STACK-UP DIAGRAM



-SOLDER MASK (TOP-SLD)
-COPPER LAYER 1(L1), .5 OZ.
-CORE 1, .0079 MEGTRON-7 R5785(N/GN)
-COPPER LAYER 2 (L2), .5 OZ.
-PREPREG, .0035 (89 um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078
-PREPREG, .0035 (89 um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078
-COPPER LAYER 3 (L3), .5 OZ.
-CORE 2, .0079 MEGTRON-7 R5785(N/GN)
-COPPER LAYER 4 (L4), .5 OZ.

1. TOTAL FINISHED THICKNESS 0.026±.004.
2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
3. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
4. L2, L3, AND L4 ARE CONTINUOUS GROUND PLANES.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP ARE SHOWN FOR MEGTRON-7 R5785(N/GN) WITH DIELECTRIC THICKNESS .0079", COPPER: 1 OZ. EACH LAYER. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
3. LAYERS L2, L3 & L4 OF PCB ARE CONTINUOUS GROUND PLANES.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	09/15/25
TOLERANCES ON:	CHECKED	GF	09/15/25
2 PL DECIMALS ±	APPROVED	IL	09/15/25
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE , MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

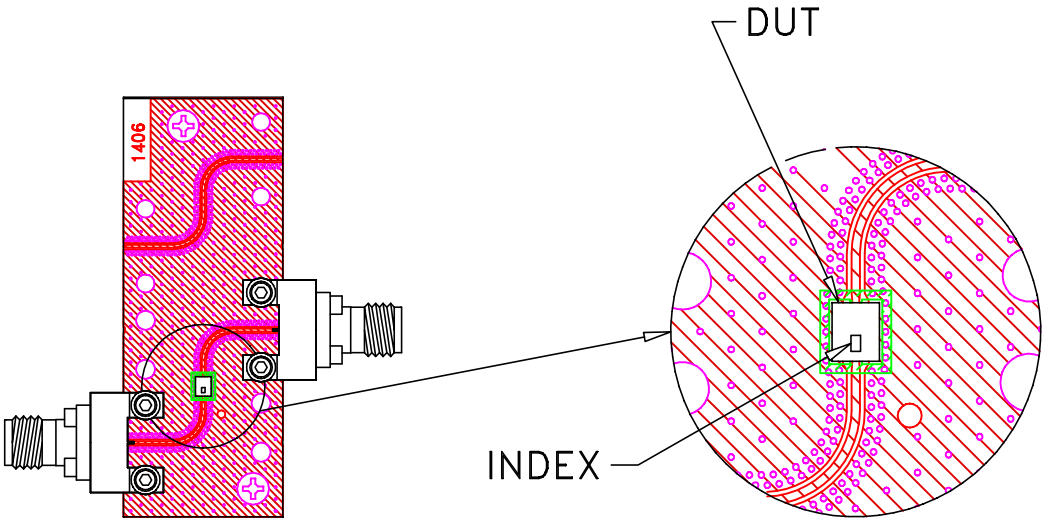
ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

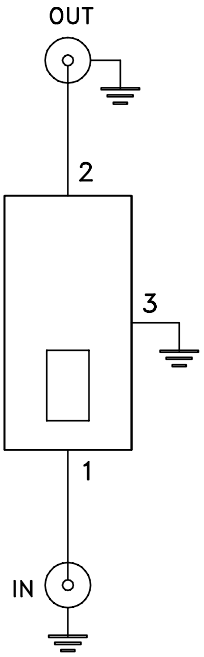
PL, NM3723, TB-LFHKI-XXXXC+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-836	OR
FILE: 98PL836	SCALE: 8:1	SHEET: 1 OF 1	

Evaluation Board and Circuit



TB-LFHKI-3800C+



Schematic Diagram

1. 50 Ohm 2.4 mm Female end Launch connectors.
2. PCB Material: MEGTRON-7 R5785(N or GN) or equivalent, Dielectric Constant= 3.37 Thickness=.0079 inch.

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS.

Mini-Circuits

Environmental Specifications ENV06T10

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-55° to +125°C, 15 min dwell,250 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---

This document and its contents are the property of Mini-Circuits.